



Product Change Notification

Change Notification #: 115071 - 00

Change Title: Select Intel® SSD DC S3500 Series
Products for EMC*,
PCN 115071-00, Product Design,
Capacitor Location Change

Date of Publication: November 09, 2016

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

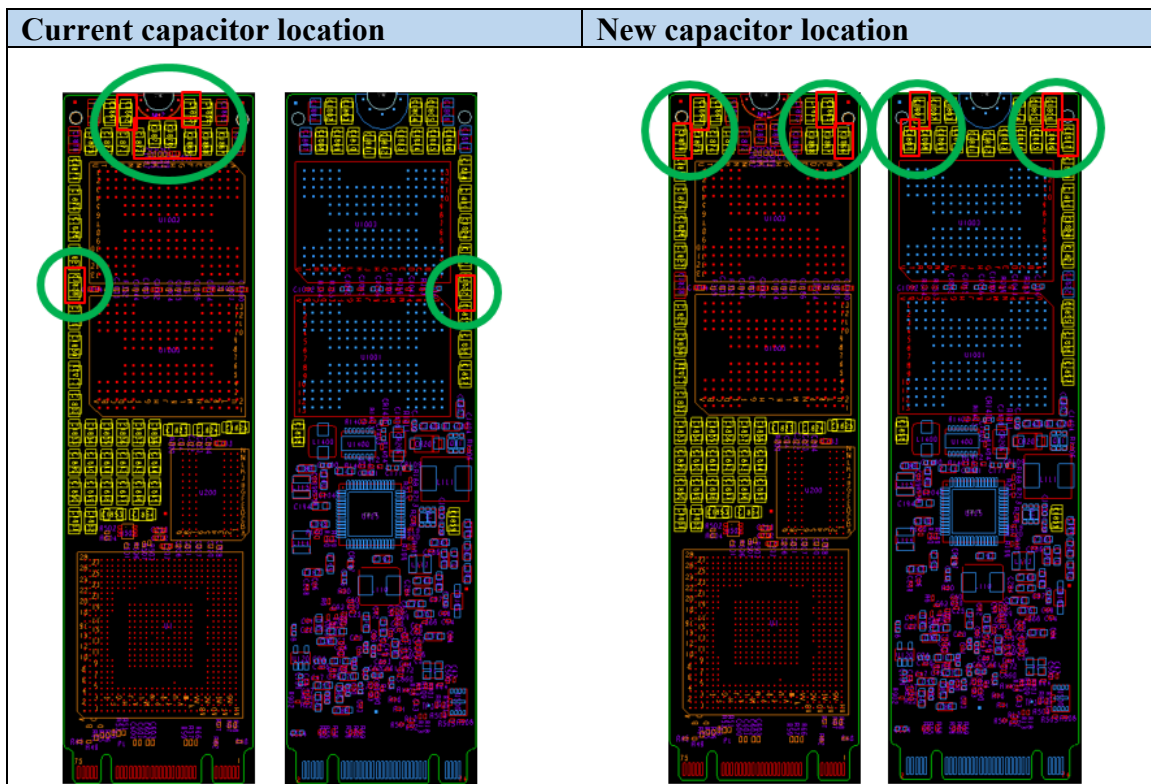
Date Customer Must be Ready to Receive Post-Conversion Material:	November 28, 2016
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Description of Change to the Customer:

For continuous improvements, the select Intel® SSD DC S3500 Series products listed in the Products Affected/Intel Ordering Codes table below will undergo the following change:

- 8 Power Loss Imminent (PLI) capacitor relocation change

Please refer to the images provided:



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers however, would like customers to be aware of the change.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Customers may contact their Intel Field Sales Representative for further questions or support.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC S3500 Series (340GB, M.2 80mm SATA 6Gb/s, 20nm, MLC) Dual Sided, EMC* Single Pack	SSDSCKHB340G4M1	941520
Intel® SSD DC S3500 Series (340GB, M.2 80mm SATA 6Gb/s, 20nm, MLC) Dual Sided, EMC* 100 Pack	SSDSCKHB340G4ME	941521

PCN Revision History:

Date of Revision:

November 09, 2016

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

115071 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com
Asia Pacific/PRC Contact: apacgccb@intel.com
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